

## FDPF680N10T N-Channel PowerTrench<sup>®</sup> MOSFET 100 V, 12 A, 68 m $\Omega$

## Features

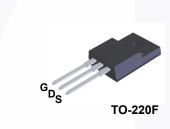
- R<sub>DS(on)</sub> = 54 mΩ (Typ.) @ V<sub>GS</sub> = 10 V, I<sub>D</sub> = 6 A
- · Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low  $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

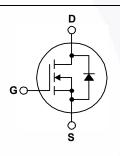
## Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench<sup>®</sup> process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

## Applications

- Consumer Appliances
- LCD/LED/PDP TV
- Synchronous Rectification
- Uninterruptible Power Supply
- Micro Solar Inverter





## MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

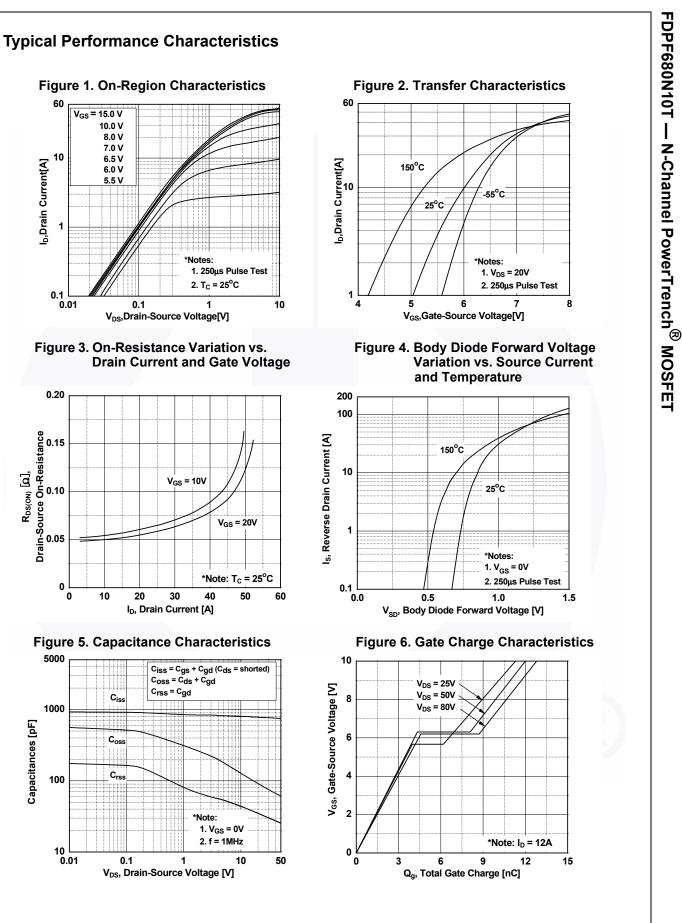
Symbol	Parameter			FDPF680N10T	Unit	
V <sub>DSS</sub>	Drain to Source Voltage			100	V	
V <sub>GSS</sub>	Gate to Source Voltage		±20	V		
ID	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		12		
	Drain Current	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		7.6	Α	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	48	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)			50.4	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		13.0	V/ns		
P <sub>D</sub>	Devuer Dissinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$		24	W	
	Power Dissipation	- Derate Above 25°C		0.19	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

## **Thermal Characteristics**

Symbol	Parameter	FDPF680N10T	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	5.2	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	0/10

		Package	Packing Method	Reel Size	Тар	e Width	Qua	ntity	
		TO-220F	220F Tube N/A		N/A		50 units		
Electrica	l Char	acteristics T <sub>c</sub> = 25°C	C unless ot	herwise noted.					
Symbol		Parameter		Test Condit	ions	Min.	Тур.	Max.	Unit
Off Chara	cteristic	S			4				1
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage		e I	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V, T <sub>C</sub> = 25 <sup>o</sup> C		100	-	-	V
ΔBV <sub>DSS</sub> /ΔTJ		own Voltage Temperature		$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		-	0.1	-	V/ºC
I <sub>DSS</sub>		Coencient		V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V		-	-	1	
	Zero Gate Voltage Drain Current			$V_{\rm DS} = 100 \text{ V}, V_{\rm GS} = 0 \text{ V}, T_{\rm C} = 150^{\circ}\text{C}$			-	500	μA
I <sub>GSS</sub>	Gate to Body Leakage Current			$V_{\rm GS} = \pm 20 \text{ V}, \text{ V}_{\rm DS} = 0$		-	-	±100	nA
On Charac	teristic	S							1
V <sub>GS(th)</sub>	Gate Th	reshold Voltage	١	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μ	ιA	2.5	3.5	4.5	V
R <sub>DS(on)</sub>	Static D	rain to Source On Resistan	ce '	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6 A		-	54	68	mΩ
9 <sub>FS</sub>	Forward	d Transconductance	١	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 12 A		-	26	-	S
Dynamic Characteristics           C <sub>iss</sub> Input Capacitance		,	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V	/	-	750	1000	pF	
C <sub>oss</sub>		Capacitance		$v_{DS} = 50 \text{ V},  v_{GS} = 0 \text{ V},$ f = 1 MHz		-	60	80	pF
C <sub>rss</sub>		e Transfer Capacitance				-	25	40	pF
Q <sub>g(tot)</sub>		ate Charge	,			-	13	17	nC
Q <sub>gs</sub>	Gate to	Source Gate Charge		V <sub>DS</sub> = 80 V, I <sub>D</sub> = 12 A V <sub>GS</sub> = 10 V	,		4	-	nC
Q <sub>gd</sub>	Gate to	Drain "Miller" Charge			(Note 4)	-	4	-	nC
Switching	Charac	teristics							
	Turn-On	n Delay Time		$V_{DD}$ = 50 V, I <sub>D</sub> = 12 A, V <sub>GS</sub> = 10 V, R <sub>G</sub> = 10 Ω		-	13	36	ns
t <sub>d(on)</sub>	Turn-On	Rise Time				-	19	48	ns
t <sub>d(on)</sub> t <sub>r</sub>		f Delay Time				-	18	46	ns
· · /	Turn-Off				(Note 4)		6	22	ns
t <sub>r</sub>		f Fall Time			(Note 4)	-	U		
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-Off	,			(Note 4)	-	0		
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-Off	f Fall Time	rce Diode I	Forward Current	(Note 4)	-	-	12	A
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Drain-Sou	Turn-Off rce Dioc Maximui	f Fall Time de Characteristics	Diode Forw	ard Current	(Note 4)	-	-	12 48	A A
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Drain-Sou	Turn-Off rce Dioc Maximu Maximu Drain to	Fall Time <b>de Characteristics</b> m Continuous Drain to Sour m Pulsed Drain to Source D Source Diode Forward Volt	Diode Forw	vard Current V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 12 A		-	-		
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> <b>Drain-Sou</b> I <sub>S</sub> I <sub>SM</sub>	Turn-Off rce Dioc Maximum Maximum Drain to Reverse	f Fall Time <b>Je Characteristics</b> m Continuous Drain to Sour m Pulsed Drain to Source D	Diode Forw tage	ard Current		-	-	48	Α

4. Essentially independent of operating temperature typical characteristics.



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10 L 0.01

60

l<sub>b</sub>,Drain Current[A] D

0.1

0.20

Drain-Source On-Resistance 01.0 01.0 01.0

0

5000

1000

100

Capacitances [pF]

0

10

Ciss

Cos

Crs

0.1

20

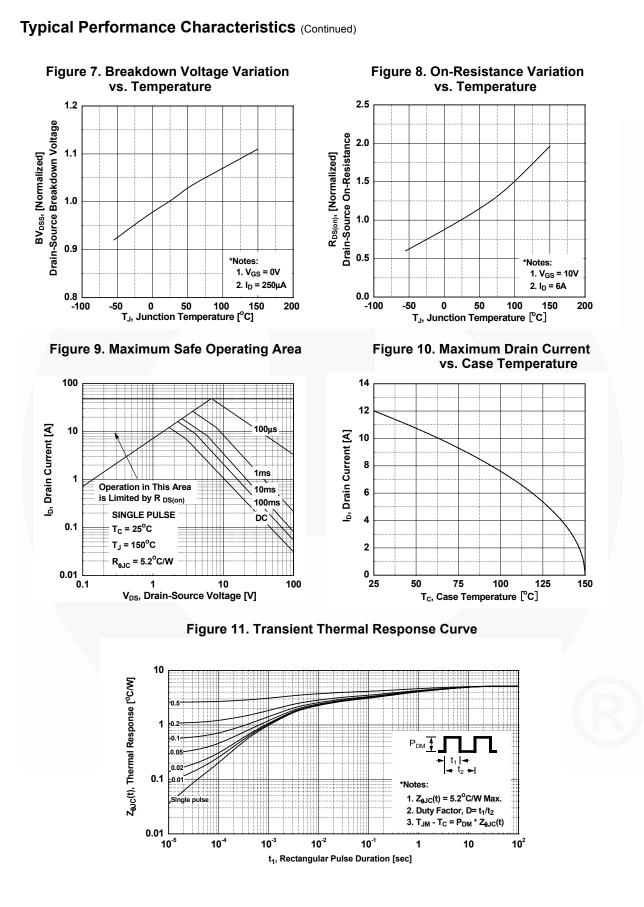
R<sub>DS(ON)</sub> [Ω],

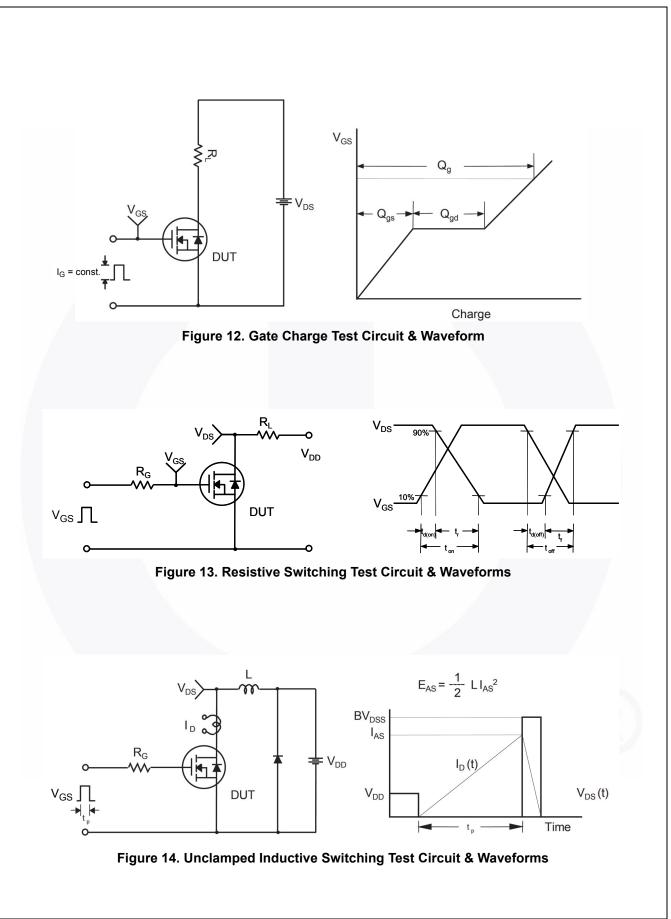
V<sub>GS</sub> = 15.0 V 10.0 V 8.0 V

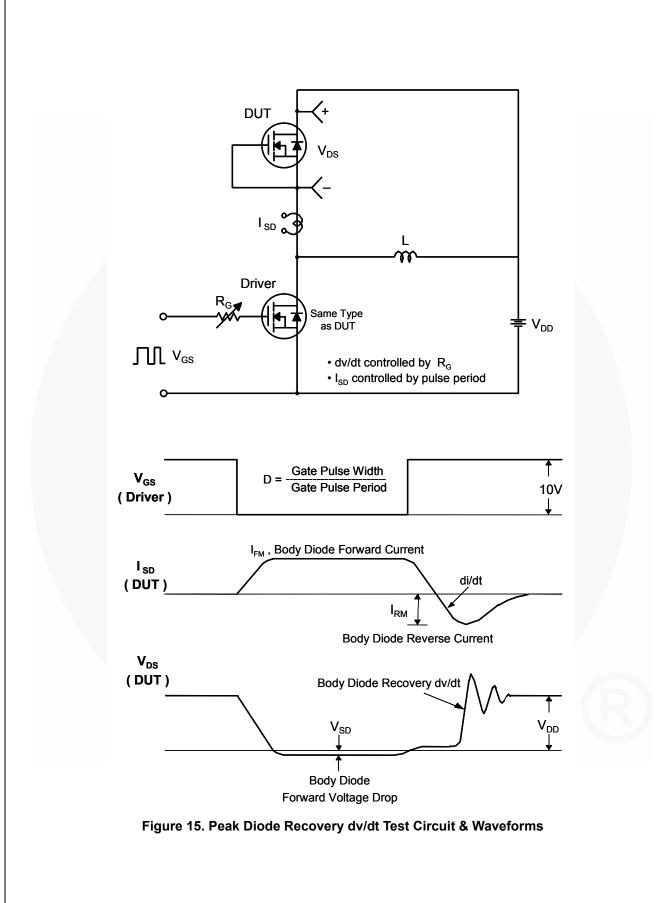
7.0 V 6.5 V

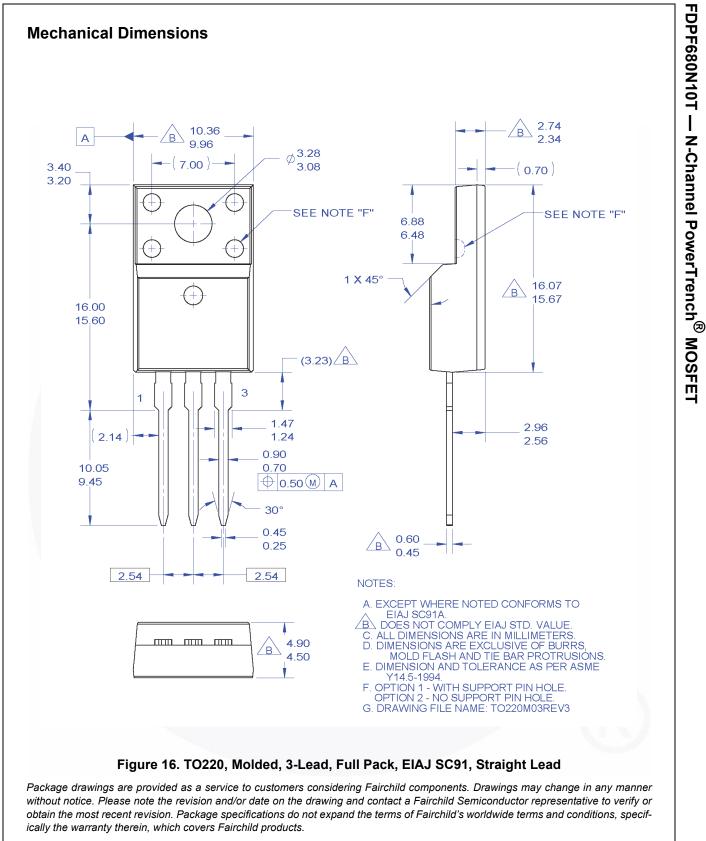
6.0 V 5.5 V

0.1









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